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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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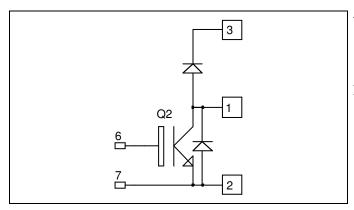




## APTGT35DA120D1

# Boost chopper Trench IGBT® Power Module

 $V_{CES} = 1200V$  $I_{C} = 35A @ Tc = 80^{\circ}C$ 

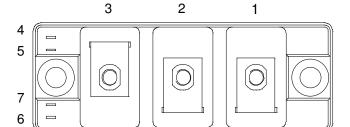


### **Application**

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

#### **Features**

- Trench + Field Stop IGBT<sup>®</sup> Technology
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 20 kHz
  - Soft recovery parallel diodes
  - Low diode VF
  - Low leakage current
  - Avalanche energy rated
  - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Low stray inductance
  - M5 power connectors
- High level of integration



### Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat

### **Absolute maximum ratings**

Symbol	Parameter		Max ratings	Unit
$V_{CES}$	Collector - Emitter Breakdown Voltage		1200	V
$I_{C}$	Continuous Collector Current	$T_C = 25^{\circ}C$	55	
	Continuous Conector Current	$T_C = 80^{\circ}C$	35	A
$I_{CM}$	Pulsed Collector Current	$T_C = 25^{\circ}C$	70	
$V_{GE}$	Gate – Emitter Voltage		±20	V
$P_D$	Maximum Power Dissipation	$T_C = 25^{\circ}C$	205	W
RBSOA	Reverse Bias Safe Operation Area	$T_j = 125$ °C	70A@1200V	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed.

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## All ratings @ $T_i = 25^{\circ}C$ unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$BV_{CES}$	Collector - Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 1.5mA$		1200			V
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{GE} = 0V, V_{CE} = 1200V$				5	mA
V <sub>CE(on)</sub>	Collector Emitter on Voltage		$T_j = 25^{\circ}C$		1.7	2.1	V
				2.0		ľ	
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$ , $I_C = 1.5 \text{mA}$		5.0	5.8	6.5	V
$I_{GES}$	Gate – Emitter Leakage Current	$V_{GE} = 20V$ , $V_{CE} = 0V$				400	nA

**Dynamic Characteristics** 

•	Characteristic	Test Conditions	Min	Typ	Max	Unit
Cies	Input Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		2.5		nF
$C_{res}$	Reverse Transfer Capacitance	f = 1MHz		0.1		111
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C)		150		
$T_{r}$	Rise Time	$V_{GE} = \pm 15V$		90		ns
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 600V$ $I_C = 35A$		550		
$T_{\mathrm{f}}$	Fall Time	$R_{G} = 27\Omega$		130		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C)		180		
$T_{r}$	Rise Time	$V_{GE} = \pm 15V$ $V_{Bus} = 600V$ $I_{C} = 35A$		100		200
$T_{d(off)}$	Turn-off Delay Time			650		ns
$T_{\mathrm{f}}$	Fall Time	$R_G = 27\Omega$		180		

Reverse diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$V_{\mathrm{F}}$	Diode Forward Voltage	$I_F = 35A$ $V_{GE} = 0V$	$T_i = 25^{\circ}C$		1.6	2.1	V
V <sub>F</sub>	Diode Forward Voltage	$V_{GE} = 0V$	$T_i = 125$ °C		1.6		· •
$E_{rec}$	Reverse Recovery Energy	$I_F = 35A$ $V_R = 600V$ $di/dt = 990A/\mu s$	$T_j = 125$ °C		2.7		mJ
	Daniera Daniera Channa	$I_F = 35A$	$T_j = 25^{\circ}C$		3.7		
$Q_{rr}$	Reverse Recovery Charge	$V_R = 600V$ di/dt =990A/µs	$T_j = 125$ °C		6.8		μC

Thermal and package characteristics

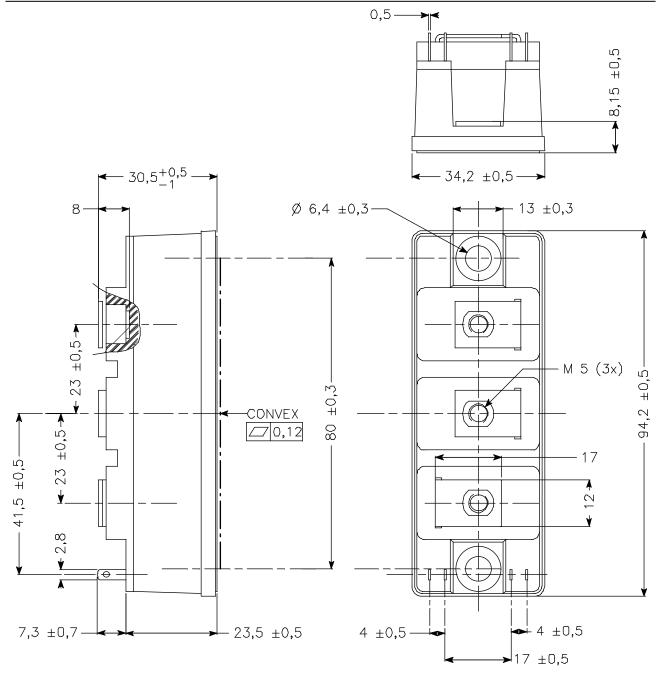
Symbol	Characteristic			Min	Тур	Max	Unit
$R_{thJC}$	Junction to Case IGBT Diode		IGBT			0.6	°C/W
TthJC			Diode			0.95	
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz			2500			V
$T_{J}$	Operating junction temperature range			-40		150	
$T_{STG}$	Storage Temperature Range			-40		125	°C
$T_{\rm C}$	Operating Case Temperature			-40		125	
Torque	Mounting torque	For terminals	M5	2		3.5	N.m
		To Heatsink	M6	3		5	11.111
Wt	Package Weight					180	g

## Package outline

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# APTGT35DA120D1



#### APT reserves the right to change, without notice, the specifications and information contained herein

APT's products are covered by one or more of U.S patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S and Foreign patents pending. All Rights Reserved.